

PRODUCT FEATURES

- ☐ High Short Circuit Capability
- ☐ Free wheeling diodes with fast and soft reverse recovery
- ☐ $V_{CE(sat)}$ with positive temperature coefficient
- ☐ Ultra Low Loss, High Ruggedness
- ☐ UL recognized, file no. E332185



APPLICATIONS

- ☐ Inverter Convertor
- ☐ Welder SMPS and UPS
- ☐ Induction Heating

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS

 $T_C = 25^{\circ}C$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J = 25^{\circ}C$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C = 25^{\circ}C$	300	A
		$T_C = 80^{\circ}C$	200	
I_{CM}	Repetitive Peak Collector Current	$t_p = 1ms$	400	
P_{tot}	Power Dissipation Per IGBT		1388	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS

 $T_C = 25^{\circ}C$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J = 25^{\circ}C$	1200	V
$I_{F(AV)}$	Average Forward Current	$T_C = 25^{\circ}C$	200	A
I_{FRM}	Repetitive Peak Forward Current	$t_p = 1ms$	400	
I^2t		$T_J = 125^{\circ}C, t = 10ms, V_R = 0V$	12800	A^2S

IGBT-inverter

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
V _{GE(th)}	Gate Emitter Threshold Voltage	V _{CE} =V _{GE} , I _C =8mA	5.0	6.2	7.0	V	
V _{CE(sat)}	Collector Emitter Saturation Voltage	I _C =200A, V _{GE} =15V, T _J =25℃		1.8	2.4		
		I _C =200A, V _{GE} =15V, T _J =125℃		2.0			
I _{CES}	Collector Leakage Current	V _{CE} =1200V, V _{GE} =0V, T _J =25℃			1	mA	
		V _{CE} =1200V, V _{GE} =0V, T _J =125℃			10	mA	
I _{GES}	Gate Leakage Current	V _{CE} =0V, V _{GE} =±15V, T _J =25℃	-400		400	nA	
R _{gint}	Integrated Gate Resistor			1		Ω	
Q _g	Gate Charge	V _{CE} =600V, I _C =200A , V _{GE} =±15V		2.1		μC	
C _{ies}	Input Capacitance	V _{CE} =25V, V _{GE} =0V, f =1MHz		14.9		nF	
C _{res}	Reverse Transfer Capacitance			0.68		nF	
t _{d(on)}	Turn on Delay Time	V _{CC} =600V, I _C =200A R _G =3.6Ω, V _{GE} =±15V, Inductive Load	T _J =25℃	100		ns	
			T _J =125℃	110		ns	
t _r	Rise Time		T _J =25℃	65		ns	
			T _J =125℃	70		ns	
t _{d(off)}	Turn off Delay Time		T _J =25℃	460		ns	
			T _J =125℃	530		ns	
t _f	Fall Time		T _J =25℃	70		ns	
			T _J =125℃	90		ns	
E _{on}	Turn on Energy	V _{CC} =600V, I _C =200A R _G =3.6Ω, V _{GE} =±15V, Inductive Load	T _J =25℃	10		mJ	
			T _J =125℃	11.5		mJ	
E _{off}	Turn off Energy		T _J =25℃	14		mJ	
			T _J =125℃	20		mJ	
I _{sc}	Short Circuit Current		tpsc≤10μS , V _{GE} =15V T _J =125℃, V _{CC} =900V		940		A
R _{thJC}	Junction to Case Thermal Resistance （ Per IGBT ）				0.09	K /W	

Diode-inverter

ELECTRICAL CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V _F	Forward Voltage	I _F =200A , V _{GE} =0V, T _J =25℃		1.95	2.4	V
		I _F =200A , V _{GE} =0V, T _J =125℃		1.95		
t _{rr}	Reverse Recovery Time	I _F =200A , V _R =600V dI _F /dt=-3500A/μs T _J =125℃		180		ns
I _{RRM}	Max. Reverse Recovery Current			250		A
Q _{RR}	Reverse Recovery Charge			35		μC
E _{rec}	Reverse Recovery Energy			15		mJ
R _{thJCD}	Junction to Case Thermal Resistance （ Per Diode ）				0.22	K /W

MODULE CHARACTERISTICS

 $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
T_{Jmax}	Max. Junction Temperature		150	$^\circ\text{C}$
T_{Jop}	Operating Temperature		-40~125	
T_{stg}	Storage Temperature		-40~125	
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 225	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M6)	2.5~5	Nm
Weight			300	g

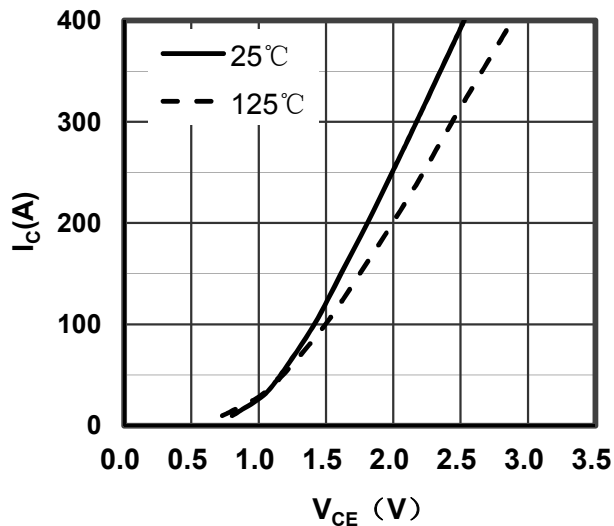


Figure 1. Typical Output Characteristics IGBT-inverter

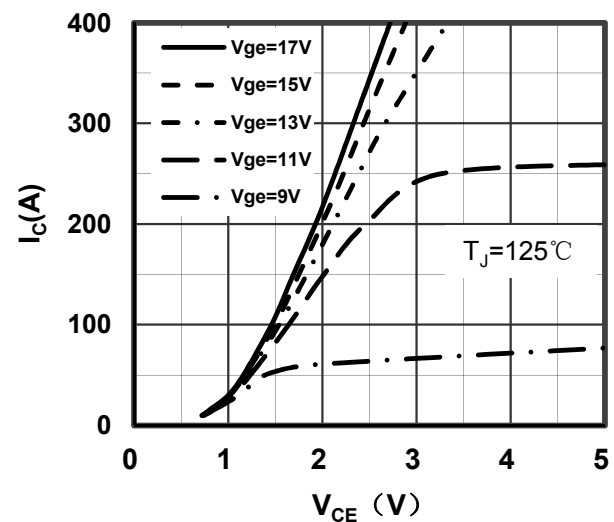


Figure 2. Typical Output Characteristics IGBT-inverter

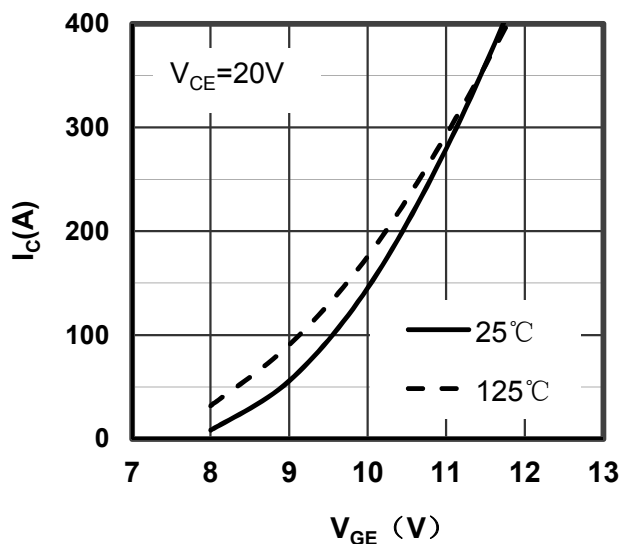


Figure 3. Typical Transfer characteristics IGBT-inverter

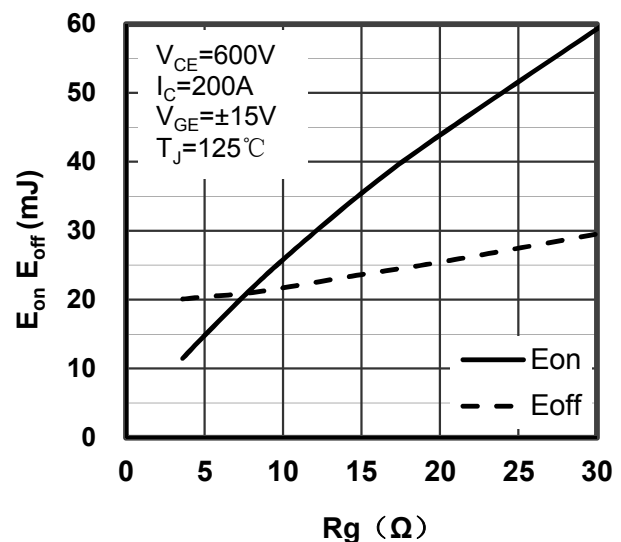


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

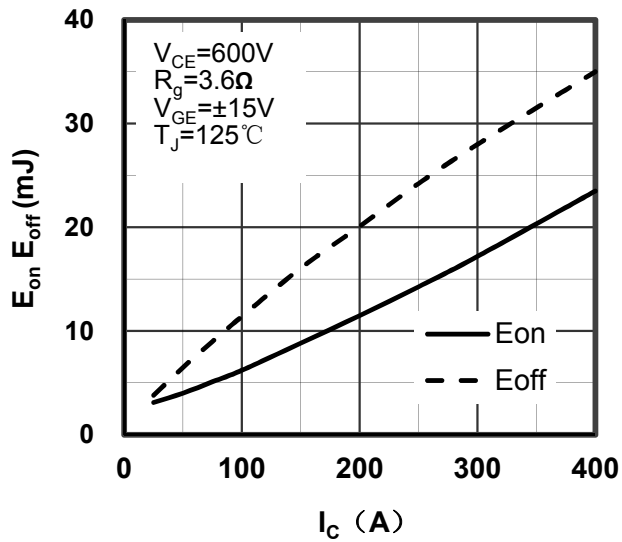


Figure 5. Switching Energy vs Collector Current IGBT-inverter

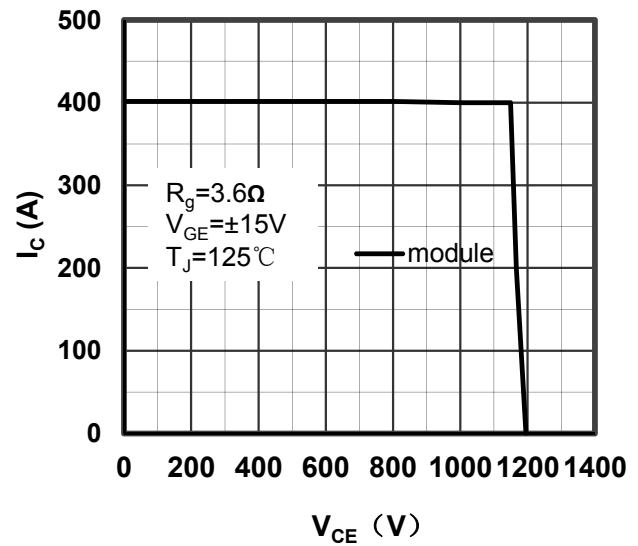


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

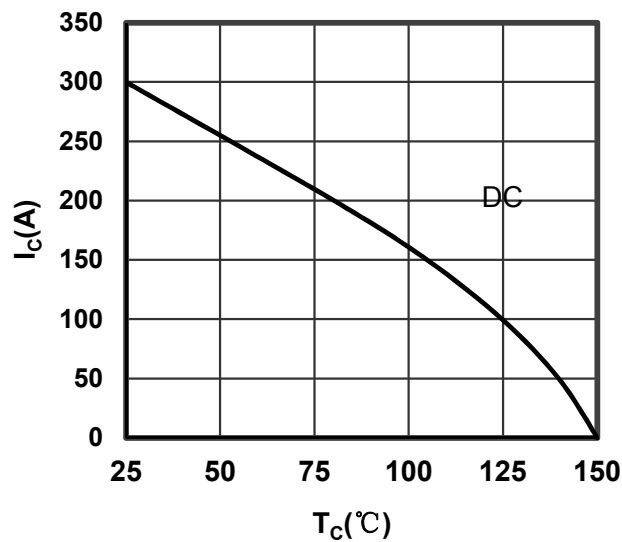


Figure 7. Collector Current vs Case temperature IGBT-inverter

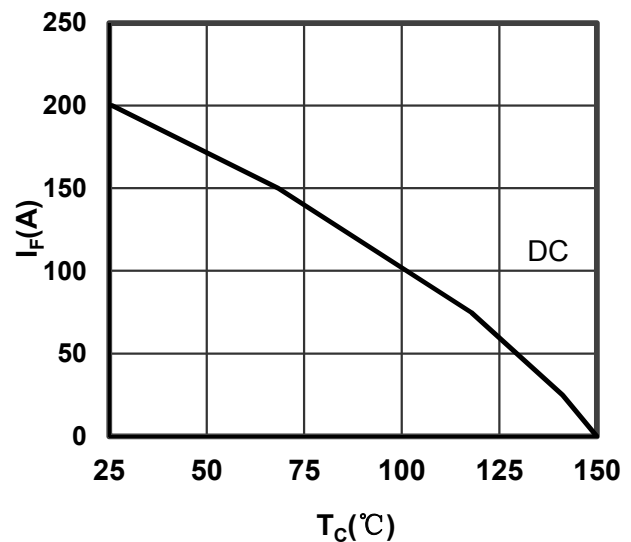


Figure 8. Forward current vs Case temperature Diode-inverter

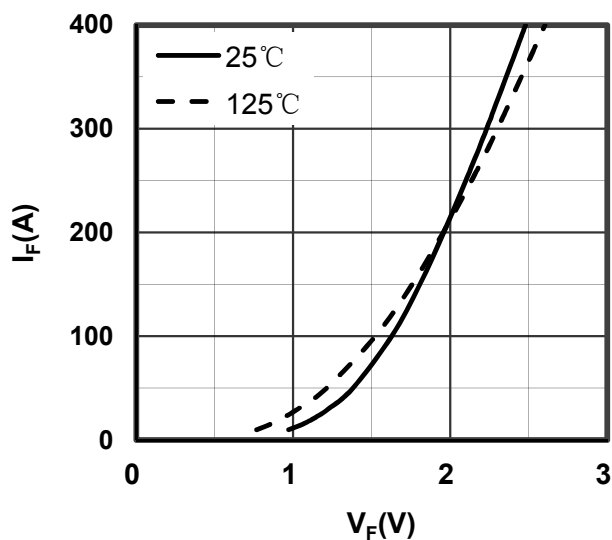


Figure 9. Diode Forward Characteristics Diode-inverter

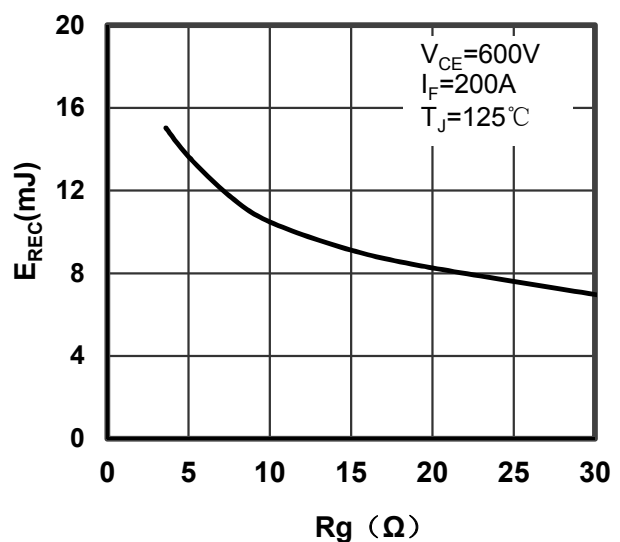


Figure 10. Switching Energy vs Gate Resistor Diode-inverter

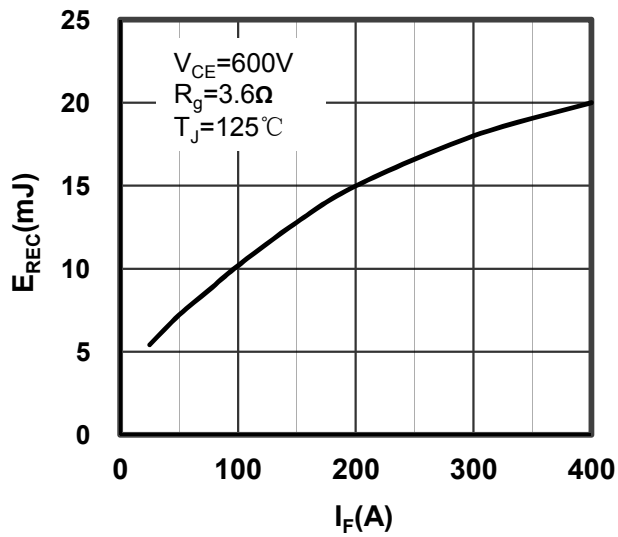


Figure 11. Switching Energy vs Forward Current Diode-inverter

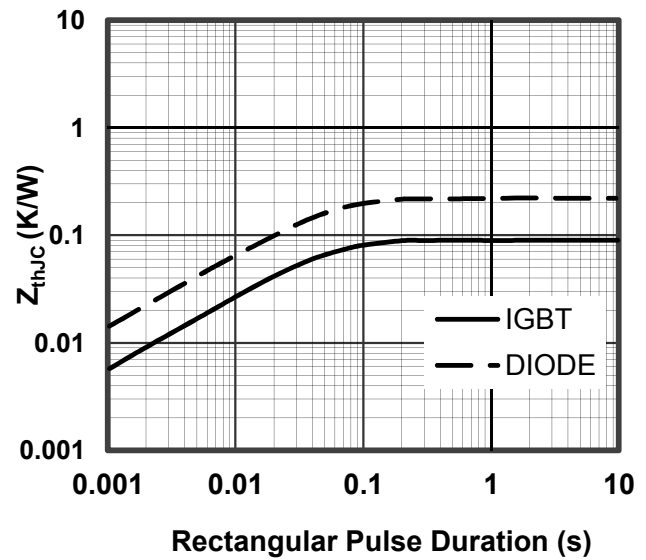


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

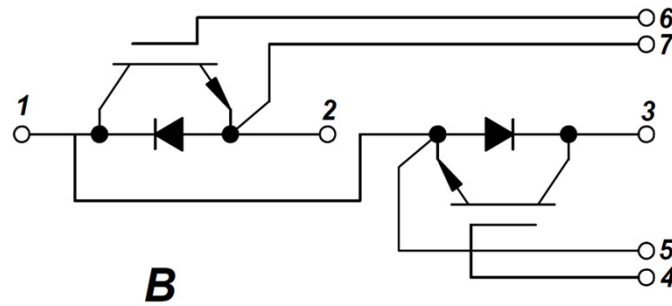
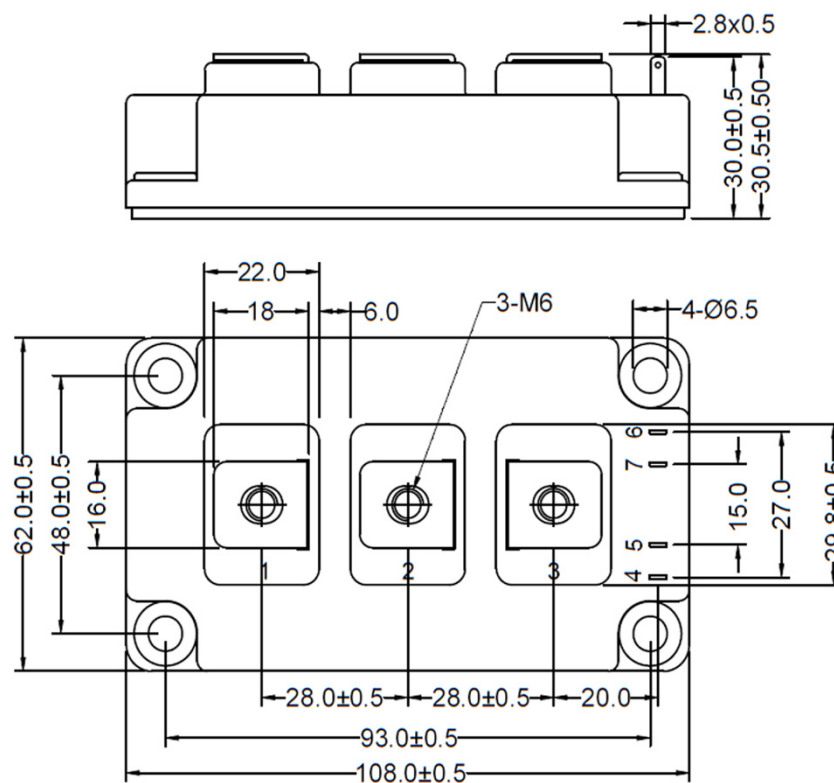


Figure 13. Circuit Diagram



Dimensions in (mm)
Figure 14. Package Outline